

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of

Applicants	:	Yoshikazu Takahashi)	Customer No.
)	*26694*
Divisional of Appln.)	
No.	:	10/300,883)	26694
)	PATENT TRADEMARK OFFICE
Filed	:	January 23, 2004)	
)	
For	:	SEMICONDUCTOR DEVICE)	
		HAVING A CHIP-SIZE PACKAGE)	
)	
Examiner	:	TBA)	
)	
Art Unit	:	TBA)	
)	
Atty. Dkt.	:	32305-200192		

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

This paper is filed concurrently with a continuation application based on co-pending application Serial Number 10/300,883 filed November 21, 2002 which is a divisional of U.S. Patent Application No. 09/663,616 filed September 18, 2002, now U.S. Patent No. 6,589,817.

Amendments to the Specification are reflected on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks begin on page 8 of this paper.